

Revision 1.00

TAPERED AMPLIFIER

GaAs Semiconductor Laser Diode



page 1 of 4

General	Product	Information	

Product	Application
780 nm Tapered Amplifier	Spectroscopy
C-Mount Package	



Absolute Maximum Ratings

Symbol	Unit	min	typ	max
T _S	°C	-40		85
T_{C}	°C	0		50
I _F	А			5
V_R	V			2
P _{opt}	W			3.2
	T _S T _C I _F V _R	T _S °C T _C °C I _F A V _R V	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	T _s °C -40 T _C °C 0 I _F A V _R V

r	non condensing
r	non condensing
	Stress in excess of one of the Absolute Maximum Ratings can cause permanent damage to the device.
9	Stress in excess of one of the Absolute Maximum

Recommended Operational Conditions

	Symbol	Unit	min	typ	max
Operational Temperature at Case	T_{C}	°C	5		40
Forward Current	I_{F}	Α			4.5
Input Power	P_{input}	mW	10		50
Output Power	P_{opt}	W			3.0

Measurement Conditions / Comments
non condensing
with proper injection from a seed laser

Characteristics at $T_{LD} = 25$ °C at Begin Of Life

Parameter	Symbol	Unit	min	typ	max
Center Wavelength	λ_{C}	nm		780	
Gain Width (FWHM)	Δλ	nm		20	
Temperature Coefficient of Wavelength	dλ / dT	nm / K		0.25	
Amplification	P _{opt}	dB	16	22	
Operational Current @ $P_{opt} = 3.0 W$	I _{op Gain}	А			4.5
Output Power @ I _F = 4.5 A	P _{opt}	W	3.0		
Cavity Length	L	μm		4000	

Measurement Conditions / Comments	
with 20-30 mW seed power	
with proper injection from a seed laser	

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Revision 1.00

2015-09-08

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gin Of Life				cont'd
Symbol	Unit	min	typ	max
d_{input}	μm		3	
d_{output}	μm		210	
Α	μm		1400	
$\Theta_{ }$	٥		18	
Θ_{\perp}	0		40	
			TM	
	$\begin{array}{c} \text{Symbol} \\ \textbf{d}_{\text{input}} \\ \textbf{d}_{\text{output}} \\ \textbf{A} \\ \Theta_{\parallel \parallel} \end{array}$	$\begin{array}{ccc} \text{Symbol} & \text{Unit} \\ \\ d_{\text{input}} & \mu m \\ \\ d_{\text{output}} & \mu m \\ \\ A & \mu m \\ \\ \Theta_{\parallel} & \circ \end{array}$	$\begin{array}{cccc} \text{Symbol} & \text{Unit} & \text{min} \\ & & \\ \text{d}_{\text{input}} & \mu \text{m} \\ & \\ \text{d}_{\text{output}} & \mu \text{m} \\ & \\ \text{A} & \mu \text{m} \\ & \\ \Theta_{\parallel \parallel} & \circ \end{array}$	$\begin{array}{c ccccc} \textbf{Symbol} & \textbf{Unit} & \textbf{min} & \textbf{typ} \\ \hline d_{input} & \mu m & 3 \\ \hline d_{output} & \mu m & 210 \\ \hline A & \mu m & 1400 \\ \hline \Theta_{ } & \circ & 18 \\ \hline \Theta_{\perp} & \circ & 40 \\ \hline \end{array}$

Measurement Conditions / Comments
Measurement Conditions / Confinents
depending on operating conditions
1 3 1 3
full beam divergence
full beam divergence
E field perpendicular to junction plane



Revision 1.00

TAPERED AMPLIFIER

GaAs Semiconductor Laser Diode



page 3 of

Package Dimensions					
Parameter	Symbol	Unit	min	typ	max
Height of Emission Plane	h	mm	7.05	7.20	7.35
C-Mount Thickness	t	mm		4.15	

Measurement Conditions / Comments

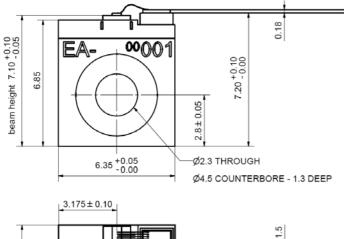
Package Pinout

Cathode (-)	Mounting Wire
Anode (+)	Housing

mounting wire (-) (+)

heat spreader

Package Drawings





Z11-SPEC-CMT04-000





Revision 1.00

TAPERED AMPLIFIER

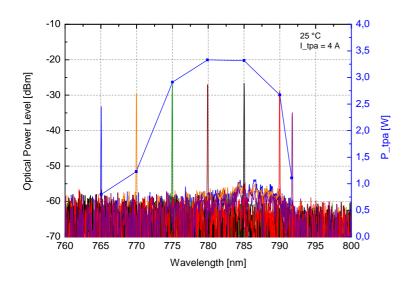
GaAs Semiconductor Laser Diode



page 4 of

Typical Measurement Results

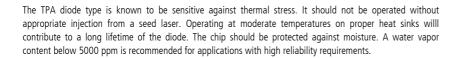
Output power at various wavelengths



Performance figures, data and any illustrative material provided in this specification are typical and must be specifically confirmed in writing by eagleyard Photonics before they become applicable to any particular order or contract. In accordance with the eagleyard Photonics policy of continuous improvement specifications may change without notice.

Unpacking, Installation and Laser Safety

Unpacking the laser diodes should only be done at electrostatic safe workstations (EPA). Though protection against electro static discharge (ESD) is implemented in the laser package, charges may occur at surfaces. Please store this product in its original package at a dry, clean place until final use. During device installation, ESD protection has to be maintained.



The laser emission from this diode is close to the invisible infrared region of the electromagnetic spectrum. Avoid direct and/or indirect exposure to the free running beam. Collimating the free running beam with optics as common in optical instruments will increase threat to the human eye.

Each laser diode will come with an individual test protocol verifying the parameters given in this document.

